

isc N-Channel MOSFET Transistor

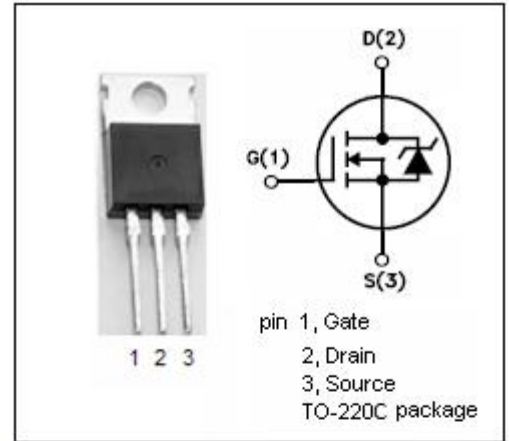
60N05-16

DESCRIPTION

- Drain Current $I_D = 60A @ T_C = 25^\circ C$
- Static Drain-Source On-Resistance : $R_{DS(on)} = 16m\Omega$ (Max)
- Fast Switching Speed
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

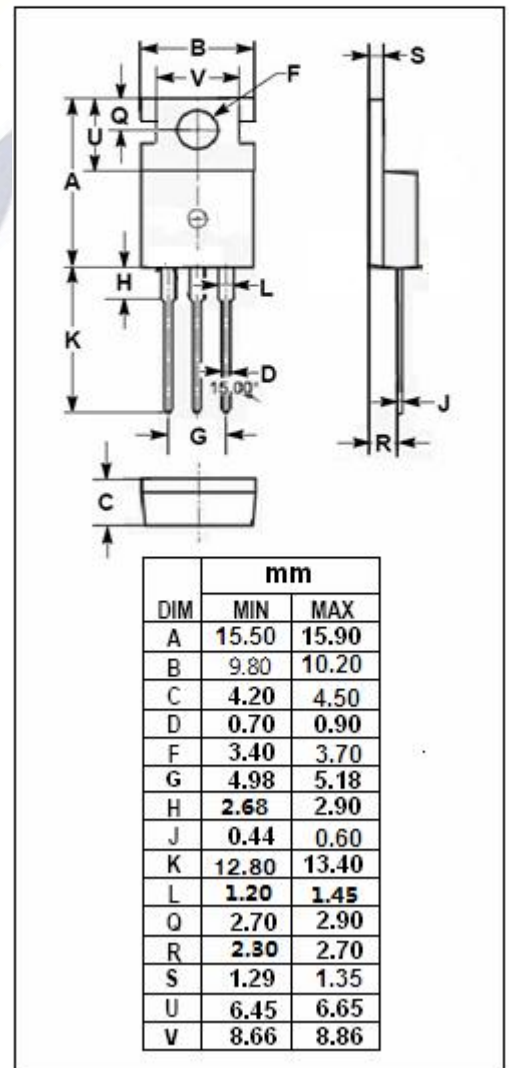
APPLICATIONS

- General purpose power amplifier
- High current, high speed switching
- Solenoid and relay drivers



ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ C$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage ($V_{GS} = 0$)	50	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-continuous@ $T_C = 25^\circ C$	60	A
	Drain Current-continuous@ $T_C = 100^\circ C$	42	
$I_{D(puls)}$	Pulse Drain Current	240	A
P_{tot}	Total Dissipation@ $T_C = 25^\circ C$	150	W
T_j	Max. Operating Junction Temperature	175	$^\circ C$
T_{stg}	Storage Temperature Range	-65~175	$^\circ C$



THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th j-c}$	Thermal Resistance, Junction to Case	1	$^\circ C/W$
$R_{th j-a}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ C/W$

isc N-Channel MOSFET Transistor**60N05-16**• ELECTRICAL CHARACTERISTICS (T_c=25°C)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0; I _D = 250μA	50			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} ; I _D =250μA	2.0		4.0	V
V _{SD}	Diode Forward On-Voltage	I _S =60A; V _{GS} = 0			1.6	V
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} = 10V; I _D =30A			16	mΩ
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V; V _{DS} = 0			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60V; V _{GS} = 0			250	μA
t _r	Rise Time	V _{GS} =10V; I _D =30A;			105	ns
t _{d(on)}	Turn-on Delay Time	V _{DD} =30V; R _G =50Ω			520	